AUTOMOTIVE GRADE

RoHS

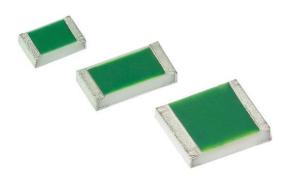
COMPLIANT

FREE

www.vishay.com

Vishay Draloric

# **High Voltage Thin Film Flat Chip Resistors**



TNPV e3 precision thin film flat chip resistors are the perfect choice for most fields of modern electronics where the highest reliability and stability at high operating voltages are of major concern. Typical applications include industrial and automotive inverters, voltage measurement systems as implemented in battery management systems, and test and measuring equipment.

#### **FEATURES**

- High operating voltage U<sub>max</sub> up to 1000 V
- Low voltage coefficient < 1 ppm/V</li>
- Excellent overall stability at different environmental conditions ≤ 0.05 % (1000 h rated power at 70 °C)





- Sulfur resistance verified according to ASTM B 809
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912"><u>www.vishay.com/doc?99912</u></a>

#### **APPLICATIONS**

- Industrial and automotive inverters
- · Battery management system
- · Test and measuring equipment

TECHNICAL SPECIFICATIONS					
DESCRIPTION	TNPV0805 e3	TNPV1206 e3	TNPV1210 e3		
Imperial size	0805	1206	1210 <sup>(1)</sup>		
Metric size code	RR2012M	RR3216M	RR3225M <sup>(1)</sup>		
Resistance range	180 k $\Omega$ to 1 M $\Omega$	160 kΩ to 2 MΩ	121 k $\Omega$ to 3.01 M $\Omega$		
Resistance tolerance		± 1 %; ± 0.5 %; ± 0.1 %			
Temperature coefficient	± 50 ppm/K; ± 25 ppm/K; ± 15 ppm/K; ± 10 ppm/K				
Voltage coefficient  c	< 1 ppm/V				
Rated dissipation, $P_{70}$ (2)	0.20 W	0.25 W	0.33 W		
Maximum operating voltage, $U_{\text{max.}}$ AC <sub>RMS</sub> or DC <sup>(3)</sup>	450 V 700 V 1000				
Permissible film temperature, $\vartheta_{\text{F max.}}^{(2)}$	155 °C				
Operating temperature range	-55 °C to 125 °C (155 °C)				
Internal thermal resistance (2)	38 K/W	32 K/W	tbd		
Failure rate: FIT <sub>observed</sub>	≤ 0.1 x 10 <sup>-9</sup> /h				

## Notes

- (1) Size not specified in EN 140401-801
- (2) Please refer to APPLICATION INFORMATION below
- (3) Application-specific safety requirements may set limitations to the applicability of the specified voltage

## **APPLICATION INFORMATION**

The power dissipation on the resistor generates a temperature rise against the local ambient, depending on the heat flow support of the printed circuit board (thermal resistance). The rated dissipation applies only if the permitted film temperature is not exceeded. Furthermore, a high level of ambient temperature or of power dissipation may raise the temperature of the solder joint, hence special solder alloys or board materials may be required to maintain the reliability of the assembly.

Please consider the application note "Thermal Management in Surface-Mounted Resistor Applications" (<a href="https://www.vishav.com/doc?28844">www.vishav.com/doc?28844</a>) for information on the general nature of thermal resistance.

These resistors do not feature a lifetime limitation when operated within the limits of rated dissipation, permissible operating voltage, and permissible film temperature. However, the resistance typically increases due to the resistor's film temperature over operating time, generally known as drift. The drift may exceed the stability requirements of an individual application circuit and thereby limits the functional lifetime. The designer may estimate the performance of the particular resistor application or set certain load and temperature limits in order to maintain a desired stability.

# Vishay Draloric

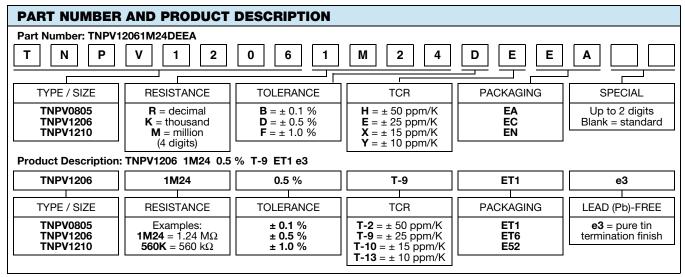
MAXIMUM RESISTANCE CHANGE AT RATED DISSIPATION					
PARAMETER	VALUE				
	TNPV0805 e3	0.20 W			
Rated dissipation, P <sub>70</sub>	TNPV1206 e3	0.25 W			
	TNPV1210 e3	0.33 W			
Applied maximum film temperature, $\vartheta_{F}$ max.	Applied maximum film temperature, $\vartheta_{F}$ max.				
	TNPV0805 e3	180 kΩ to 1 MΩ			
	TNPV1206 e3	160 kΩ to 2 MΩ			
Max. resistance change at P <sub>70</sub> for resistance range	TNPV1210 e3	121 kΩ to 3.01 MΩ			
$\Delta R/R$ , after:	1000 h	≤ 0.05 %			
	8000 h	≤ 0.10 %			
	225 000 h	≤ 0.30 %			

TEMPERATURE COEFFICIENT AND RESISTANCE RANGE						
TYPE / SIZE	TCR	TOLERANCE	RESISTANCE	E-SERIES		
	± 50 ppm/K	± 1 %		E24; E96		
	± 25 ppm/K	± 0.5 %				
TNPV0805 e3	± 23 ppi1/10	± 0.1 %	180 kΩ to 1.0 MΩ	E24; E192		
	± 15 ppm/K	± 0.1 %				
	± 10 ppm/K	± 0.1 %		1		
	± 50 ppm/K	± 1 %		E24; E96		
	± 25 ppm/K	± 0.5 %				
TNPV1206 e3		± 0.1 %	160 kΩ to 2.0 MΩ	E24: E192		
	± 15 ppm/K	± 0.1 %		E24, E192		
	± 10 ppm/K	± 0.1 %				
	± 50 ppm/K	± 1 %	121 kΩ to 3.01 MΩ	E24; E96		
TNPV1210 e3	± 25 ppm/K	± 0.5 %	12 1 K22 tO 0.0 1 W122			
	± 23 ρβΠ/Κ	± 0.1 %		E24; E192		
	± 15 ppm/K	± 0.1 %	121 kΩ to 2.13 MΩ	E24, E192		
	± 10 ppm/K	± 0.1 %				

PACKAGING						
TYPE / SIZE	CODE	QUANTITY	PACKAGING STYLE	WIDTH	PITCH	PACKAGING DIMENSIONS
TNPV0805 e3 TNPV1206 e3 TNPV1210 e3	E52 = EN	1000 <sup>(1)</sup>	Paper tape according IEC 60286-3, Type 1a	8 mm	4 mm	Ø 180 mm / 7"
	ET1 = EA	5000				Ø 160 IIII17 7
	ET6 = EC	20 000	120 00200-3, Type 1a			Ø 330 mm / 13"

#### Note

 $<sup>^{(1)}</sup>$  1000 pieces packaging is available only for precision resistors with tolerance  $\pm$  0.1 %



#### Note

ARE SUBJECT TO SPECIFIC DISCLAIMERS, SET FORTH AT www.vishav.com/doc?91000

Products can be ordered using either the PART NUMBER or the PRODUCT DESCRIPTION

# Vishay Draloric

## **DESCRIPTION**

Production is strictly controlled and follows an extensive set of instructions established for reproducibility. A homogeneous film of special metal alloy is deposited on a high grade ceramic substrate ( $Al_2O_3$ ) and conditioned to achieve the desired temperature coefficient. Specially designed inner contacts are deposited on both sides. A special laser is used to achieve the target value by smoothly fine trimming the resistive layer without damaging the ceramics. A further conditioning is applied in order to stabilize the trimming result. The resistor elements are covered by a protective coating designed for electrical, mechanical and climatic protection. The terminations receive a final pure matte tin on nickel plating.

The result of the determined production is verified by an extensive testing procedure and optical inspection performed on 100 % of the individual chip resistors. This includes full screening for the elimination of products with a potential risk of early life failures (feasible for  $R \ge 10 \,\Omega$ ). Only accepted products are laid directly into the tape in accordance with **IEC 60286-3**, **Type 1a** (1).

#### **ASSEMBLY**

The resistors are suitable for processing on automatic SMD assembly systems. They are suitable for automatic soldering using wave, reflow or vapour phase as shown in **IEC 61760-1** <sup>(1)</sup>. The encapsulation is resistant to all cleaning solvents commonly used in the electronics industry, including alcohols, esters and aqueous solutions. The suitability of conformal coatings, potting compounds and their processes, if applied, shall be qualified by appropriate means to ensure the long-term stability of the whole system.

The resistors are RoHS-compliant, the pure matte tin plating provides compatibility with lead (Pb)-free and lead-containing soldering processes. Solderability is specified for 2 years after production or requalification. The permitted storage time is 20 years. The immunity of the plating against tin whisker growth has been proven under extensive testing.

### **MATERIALS**

Vishay acknowledges the following systems for the regulation of hazardous substances:

- IEC 62474, Material Declaration for Products of and for the Electrotechnical Industry, with the list of declarable substances given therein (2)
- The Global Automotive Declarable Substance List (GADSL) (3)
- The REACH regulation (1907/2006/EC) and the related list of substances with very high concern (SVHC) (4) for its supply chain

The products do not contain any of the banned substances as per IEC 62474, GADSL, or the SVHC list, see <a href="https://www.vishay.com/how/leadfree">www.vishay.com/how/leadfree</a>.

Hence the products fully comply with the following directives:

- 2000/53/EC End-of-Life Vehicle Directive (ELV) and Annex II (ELV II)
- 2011/65/EU Restriction of the Use of Hazardous Substances Directive (RoHS) with amendment 2015/863/EU
- 2012/19/EU Waste Electrical and Electronic Equipment Directive (WEEE)

Vishay pursues the elimination of conflict minerals from its supply chain, see the Conflict Minerals Policy at <a href="https://www.vishay.com/doc?49037">www.vishay.com/doc?49037</a>.

## **RELATED PRODUCTS**

For products with ultra precision specification see the datasheet:

 TNPU e3 - Ultra Precision Thin Film Flat Chip Resistors (www.vishav.com/doc?28779)

For products with high stability specification see the

 TNPW e3 - High Stability Thin Film Flat Chip Resistors (<u>www.vishay.com/doc?28758</u>)

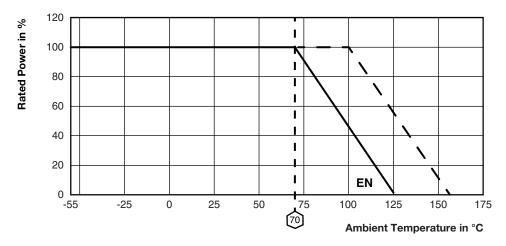
#### **Notes**

- (1) The quoted IEC standards are also released as EN standards with the same number and identical contents
- (2) The IEC 62474 list of declarable substances is maintained in a dedicated database, which is available at http://std.iec.ch/iec62474
- (3) The Global Automotive Declarable Substance List (GADSL) is maintained by the American Chemistry Council and available at <a href="https://www.gadsl.org">www.gadsl.org</a>

(4) The SVHC list is maintained by the European Chemical Agency (ECHA) and available at http://echa.europa.eu/candidate-list-table



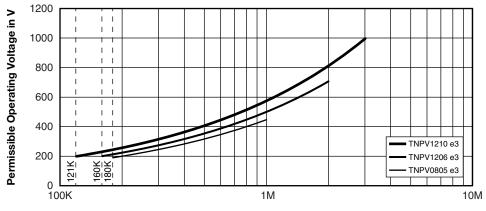
## **FUNCTIONAL PERFORMANCE**



## **Derating**

#### Note

 The solid line is based on IEC/EN reference test conditions which is considered as standard mode. However, above that the maximum permissible film temperature is 155 °C (dashed line)



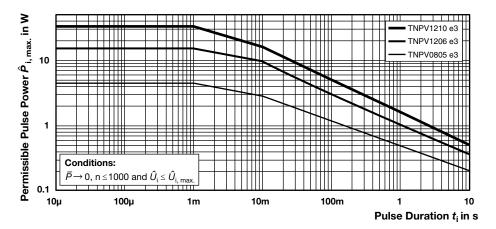
#### Resistance Value in $\Omega$

## **Nominal Operating Voltage**

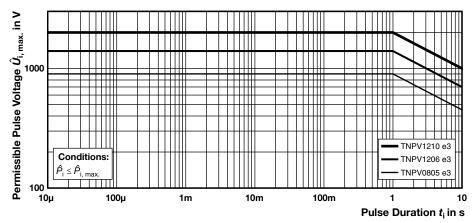
## Note

 The permissible operating voltage equals the rated voltage U<sub>R</sub> = √P<sub>70</sub> x R . For ambient temperatures above 70 °C power derating must be considered





# Maximum Pulse Load $\hat{P}_{i, max.}$ Single Pulses



Maximum Pulse Voltage  $\hat{U}_{i, max.}$ 



# Vishay Draloric

## **TEST AND REQUIREMENTS**

All tests are carried out in accordance with the following specifications:

EN 60115-1, generic specification

EN 60115-8 (successor of EN 140400), sectional specification

EN 140401-801, detail specification

IEC 60068-2-xx, test methods

The parameters stated in the Test Procedures and Requirements table are based on the required tests and permitted limits of EN 140401-801. The table presents only the most important tests, for the full test schedule refer to the documents listed above. However, some additional tests and a number of improvements against those minimum requirements have been included.

The testing also covers most of the requirements specified by EIA / ECA-703 and JIS-C-5201-1.

The tests are carried out under standard atmospheric conditions in accordance with IEC 60068-1, 4.3, where upon the following values are applied:

Temperature: 15 °C to 35 °C Relative humidity: 25 % to 75 %

Air pressure: 86 kPa to 106 kPa (860 mbar to 1060 mbar)

A climatic category LCT / UCT / 56 is applied, defined by the lower category temperature (LCT), the upper category temperature (UCT), and the duration of exposure in the damp heat, steady state test (56 days).

The components are mounted for testing on printed circuit boards in accordance with EN 60115-8, 2.4.2, unless otherwise specified.

TEST PR	TEST PROCEDURES AND REQUIREMENTS						
EN 60115-1 CLAUSE	IEC 60068-2 (1) TEST TEST PROC		PROCEDURE	REQUIREMENTS PERMISSIBLE CHANGE ( $\Delta R$ )			
			Stability for product types:				
			TNPV0805 e3	180 kΩ to 1 MΩ			
			TNPV1206 e3	160 kΩ to 2 MΩ			
			TNPV1210 e3	121 kΩ to 3.01 MΩ			
4.5	-	Resistance	-	± 1 %; ± 0.5 %; ± 0.1 %			
4.8.4.2	-	Temperature coefficient	At (20 / -55 / 20) °C and (20 / 125 / 20) °C	± 50 ppm/K; ± 25 ppm/K; ± 15 ppm/K; ± 10 ppm/K			
		Endurance	<i>U</i> = <i>U</i> <sub>max.</sub> ; 1.5 h on; 0.5 h off;				
4.25.1	-	at 70 °C	70 °C; 1000 h	± (0.05 % R)			
			70 °C; 8000 h	± (0.1 % R)			
		Endurance at	125 °C; 1000 h	± (0.05 % R)			
4.25.3	-	upper category temperature	155 °C; 1000 h	± (0.1 % R)			
4.24	78 (Cab)	Damp heat, steady state	(40 ± 2) °C; 56 days; (93 ± 3) % RH; U = 0.1 x U <sub>max</sub> .	± (0.1 % R)			
4.19	14 (Na)	Rapid change of temperature	30 min at LCT and 30 min at UCT; LCT = -55 °C; UCT = 125 °C; 1000 cycles	± (0.1 % R)			
4.13	-	Short time overload	U = 2 x permissible operating voltage; 5 s	± (0.05 % R)			
4.27	-	Single pulse high voltage overload	Severity no. 4: $U = 2 \times U_{\text{max}};$ 10 pulses 10 µs/700 µs	± (0.1 % R)			
4.39	-	Periodic electric overload	$U = 2 \times U_{\text{max.}};$ 0.1 s on; 2.5 s off; 1000 cycles	± (0.1 % R)			
4.22	6 (Fc)	Vibration	Endurance by sweeping; 10 Hz to 2000 Hz; no resonance; amplitude $\leq$ 1.5 mm or $\leq$ 200 m/s <sup>2</sup> ; 7.5 h	± (0.05 % <i>R</i> )			



www.vishay.com

# Vishay Draloric

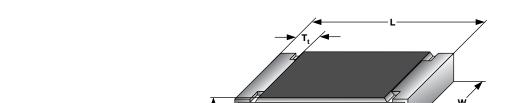
EN 60115-1 CLAUSE	IEC 60068-2 (1) TEST METHOD	TEST	PROCEDURE	REQUIREMENTS PERMISSIBLE CHANGE ( $\Delta R$ )
			Stability for product types:	
			TNPV0805 e3	180 kΩ to 1 MΩ
			TNPV1206 e3	160 k $\Omega$ to 2 M $\Omega$
			TNPV1210 e3	121 kΩ to 3.01 MΩ
4.38	-	Electrostatic discharge (Human Body Model)	IEC 61340-3-1 <sup>(1)</sup> ; 3 pos. + 3 neg. discharges; TNPV0805 e3: 2 kV TNPV1206 e3, TNPV1210 e3: 6 kV	± (0.5 % R)
			Solder bath method; SnPb40; non-activated flux $(215 \pm 3)$ °C; $(3 \pm 0.3)$ s	Good tinning (≥ 95 % covered);
4.17.2	58 (Td) Soldera	Solderability	Solder bath method; SnAg3Cu0.5 or SnAg3.5; non-activated flux $(235 \pm 3)$ °C; $(2 \pm 0.2)$ s	no visible damage
		Resistance to	Solder bath method; $(260 \pm 5)$ °C; $(10 \pm 1)$ s	
4.18.2	58 (Td)	soldering heat	Reflow method 2 (IR/forced gas convection); $(260 \pm 5)$ °C; $(10 \pm 1)$ s	± (0.02 % R)
4.29	45 (XA)	Component solvent resistance	Isopropyl alcohol; 50 °C; method 2	No visible damage
4.30	45 (XA)	Solvent resistance of marking	Isopropyl alcohol; 50 °C; method 1, toothbrush	No visible damage
4.32	21 (Ue <sub>3</sub> )	Shear (adhesion)	45 N	No visible damage
4.33	21 (Ue <sub>1</sub> )	Substrate bending	Depth 2 mm, 3 times	± (0.05 % R) no visible damage, no open circuit in bent position
4.35	-	Flammability	IEC 60695-11-5 <sup>(1)</sup> , needle flame test; 10 s	No burning after 30 s
4.37	67 (Cy)	Damp heat, steady state, accelerated	(85 ± 2) °C; (85 ± 5) % RH; <i>U</i> = 0.3 x <i>U</i> <sub>max</sub> ; 1000 h	± (0.25 % <i>R</i> )

## Note

<sup>(1)</sup> The quoted IEC standards are also released as EN standards with the same number and identical contents



**DIMENSIONS** 



DIMENSIONS AND MASS								
TYPE / SIZE H (mm)		L (mm)	W (mm)	T <sub>t</sub> / T <sub>b</sub> (mm)	MASS (mg)			
TNPV0805 e3	0.45 ± 0.10	2.0 ± 0.1	1.25 ± 0.15	0.4 ± 0.20	5.5			
TNPV1206 e3	0.55 ± 0.10	3.2 + 0.1 / - 0.2	1.6 ± 0.15	0.5 ± 0.25	10			
TNPV1210 e3	0.60 ± 0.15	3.2 + 0.1 / - 0.2	2.45 ± 0.15	0.5 ± 0.25	16			

## **SOLDER PAD DIMENSIONS**



RECOMMENDED SOLDER PAD DIMENSIONS							
TYPE / SIZE	R	EFLOW SOLDERIN	ıg	WAVE SOLDERING			
	Y (mm)	X (mm)	G (mm)	Y (mm)	X (mm)	G (mm)	
TNPV0805 e3	0.7	1.3	1.2	0.9	1.3	1.3	
TNPV1206 e3	0.9	1.7	2.0	1.1	1.7	2.3	
TNPV1210 e3	0.9	2.5	2.0	1.1	2.5	2.3	

#### Note

• Utilization of the full specified operating voltage may require special considerations on the creepage and clearance distance between conductors at different potential levels



# **Legal Disclaimer Notice**

Vishay

# **Disclaimer**

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Hyperlinks included in this datasheet may direct users to third-party websites. These links are provided as a convenience and for informational purposes only. Inclusion of these hyperlinks does not constitute an endorsement or an approval by Vishay of any of the products, services or opinions of the corporation, organization or individual associated with the third-party website. Vishay disclaims any and all liability and bears no responsibility for the accuracy, legality or content of the third-party website or for that of subsequent links.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.